Part Number : 741640006
Product Description : 2.54mm Pitch C-Grid Receptacle, Right-Angle, Through Hole, Dual Row, Shrouded with Pegs, Version A, High-Temperature, 6 Circuits, 0.40µm Gold (Au)
Series Number : 74164
Status : Active
Product Category : PCB Headers and Receptacles



Documents & Resources

Drawings

741640006_sd.pdf

PK-70873-0019-001.pdf

PK-74163-9000-001.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

713080001-AS-000.pdf

PS-74164-001-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	74164
Description	2.54mm Pitch C-Grid Receptacle, Right-Angle, Through Hole, Dual Row, Shrouded with Pegs, Version A, High-Temperature, 6 Circuits, 0.40µm Gold (Au)
Application	Board-to-Board, Signal
Component Type	PCB Receptacle
Product Name	C-Grid
UPC	883906878436

Agency

UL	E29179

Electrical

Current - Maximum per Contact	2.5A
Grounding to PCB	No
Voltage - Maximum	250V

Physical

Circuits (Loaded)	6
Circuits (maximum)	6
Color - Resin	Black
Durability (mating cycles max)	50
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	Yes
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Performance Thermoplastic
Net Weight	2.314/g
Number of Rows	2
Orientation	Right Angle
Packaging Type	Tube
PCB Locator	Yes
PCB Retention	None
PCB Thickness - Recommended	3.18mm
Pitch - Mating Interface	2.54mm
Pitch - Termination Interface	2.54mm
Plating min - Mating	0.381µm
Plating min - Termination	1.910µm
Polarized to Mating Part	No
Polarized to PCB	No
Robotic Placement	None
Stackable	No
Temperature Range - Operating	-40° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	5

Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	260